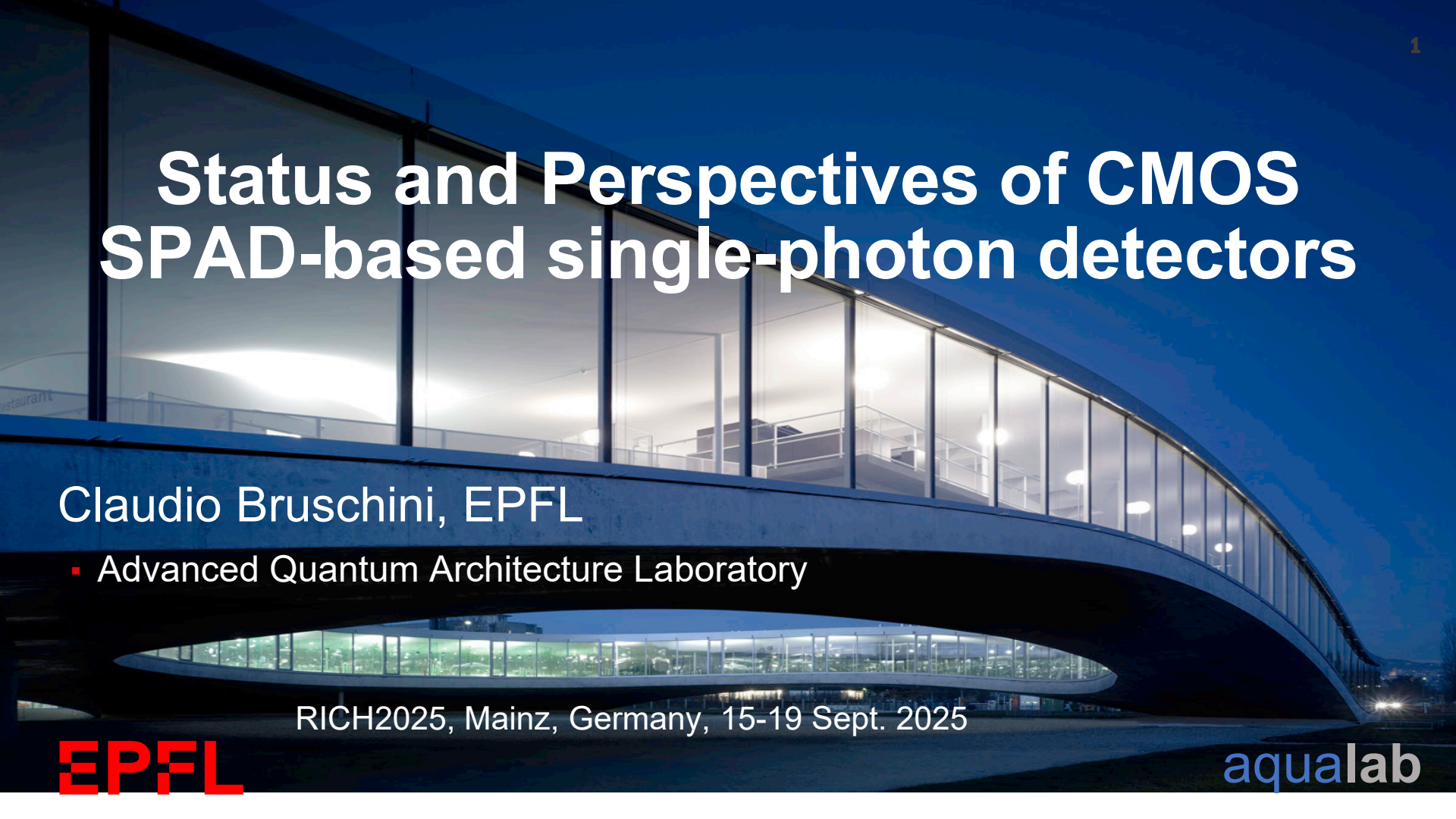




Status and Perspectives of CMOS SPAD-based single-photon detectors

Claudio Bruschini, EPFL

- Advanced Quantum Architecture Laboratory

RICH2025, Mainz, Germany, 15-19 Sept. 2025

EPFL

aqualab

Introduction – Analog vs digital SiPMs

SPAD: single-photon avalanche diode
SiPM: silicon photomultiplier

Single-photon Avalanche Diodes (SPADs) Metrics

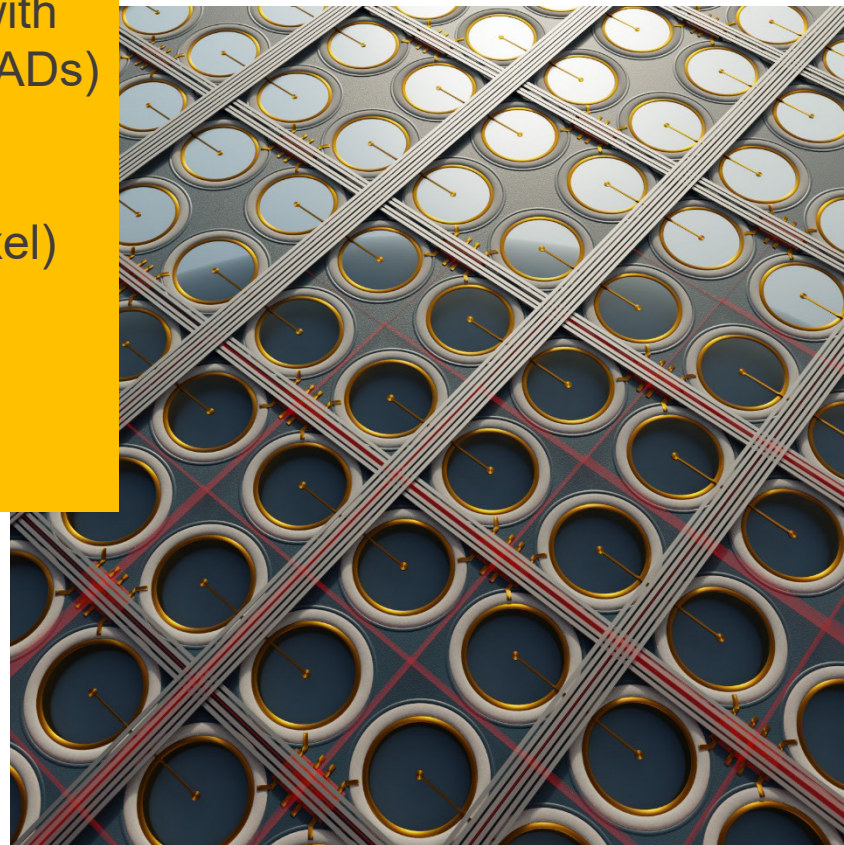
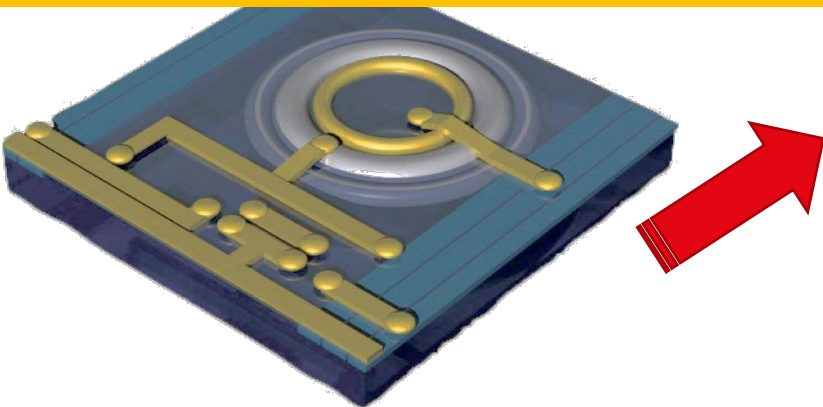
Detect/time-stamp single optical photons with CMOS Single-photon Avalanche Diodes (SPADs)

High sensitivity (up to 90% PDP)

Low noise (10-100 counts-per-second / pixel)

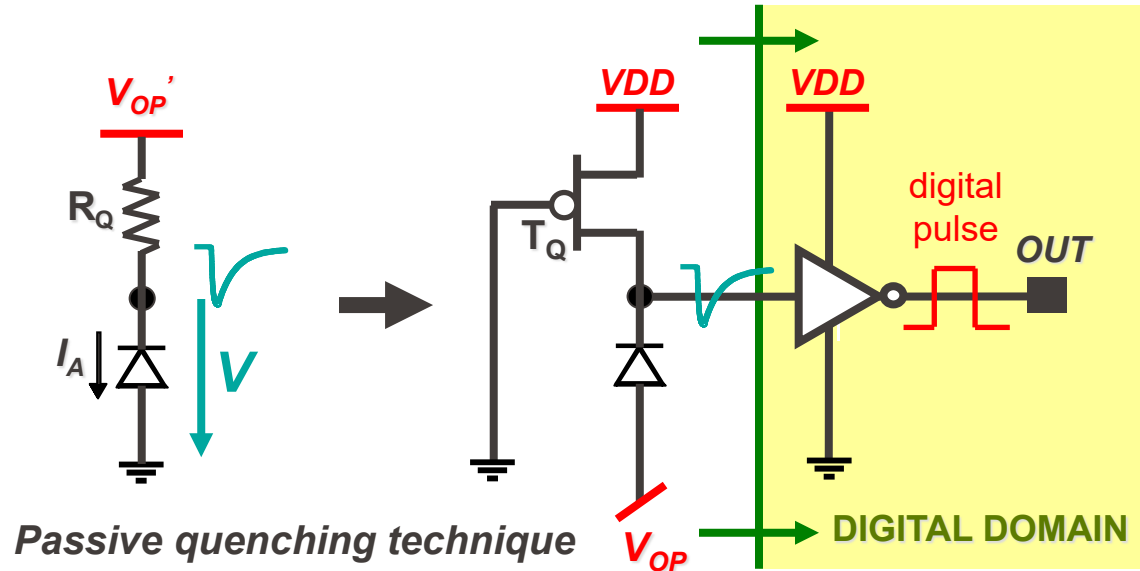
Excellent timing resolution (10-100 ps)

Increasing spatial resolution (kpx - Mpx)

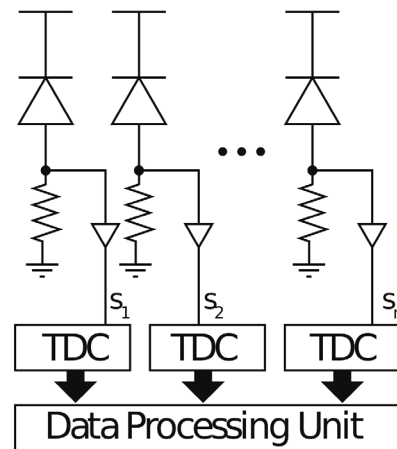
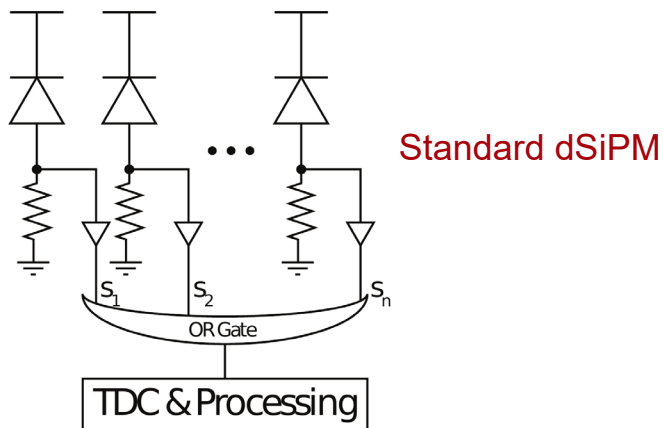
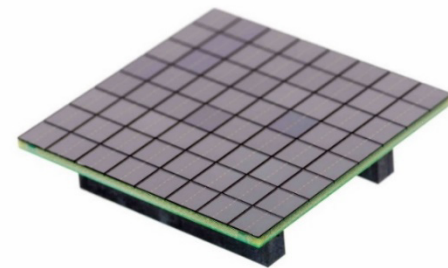
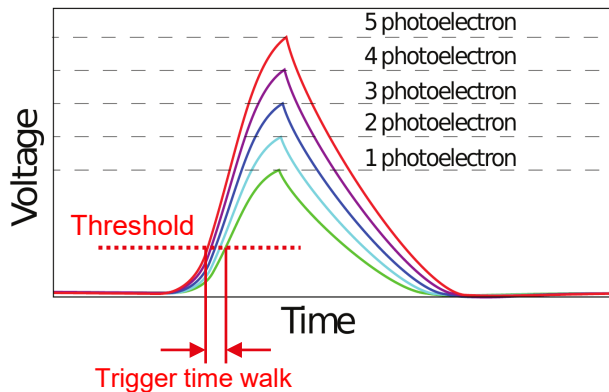
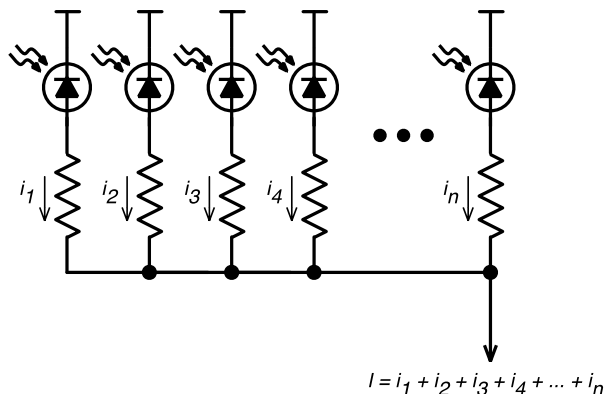


SPADs as digital devices in CMOS

- The SPAD becomes like any other digital device but it is triggered by a photon!



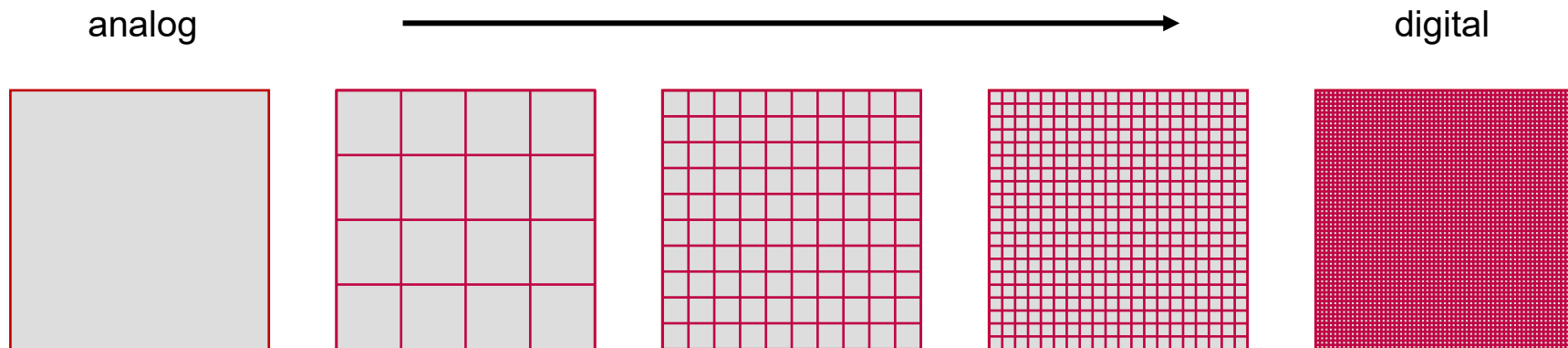
- With two more switches one can gate sensitivity



Ideal (multi-channel)
dSiPM

[S. Mandai & E. Charbon,
NSS-MIC 2012;
E. Venialgo, NSS-MIC 2016]

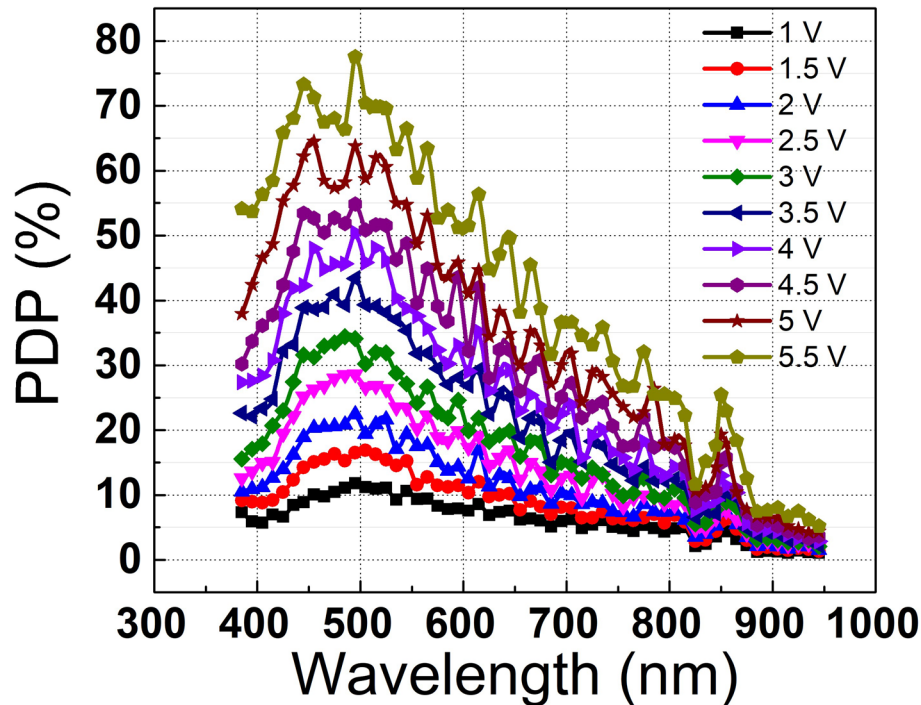
Transition from analog to digital



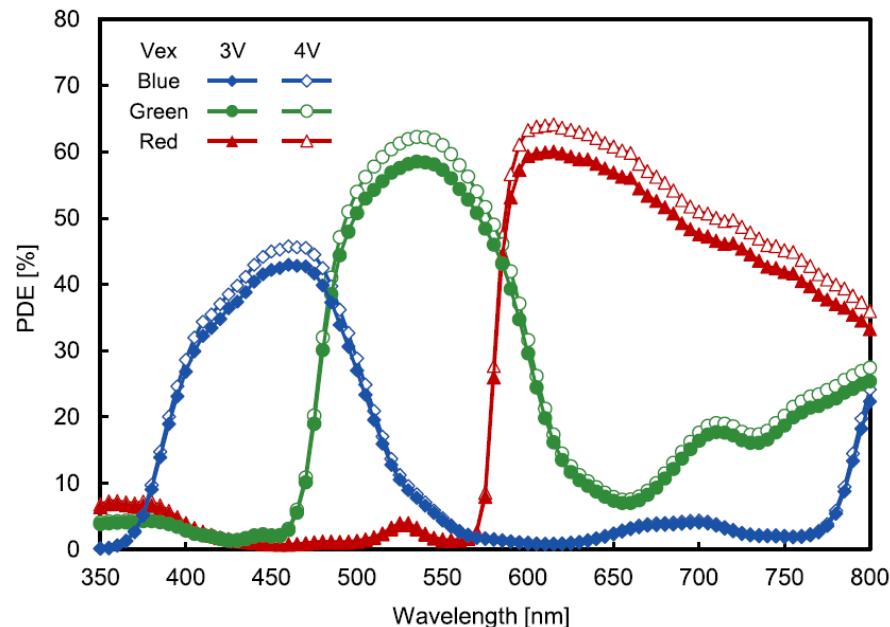
Is it necessary to go for a fully digital SiPM?

SPAD Metrics: recent Improvements & Trends

Photon Detection Probability (PDP): recent results



U. Karaca, et al, IISW 2023
FSI 110 nm (monolithic)

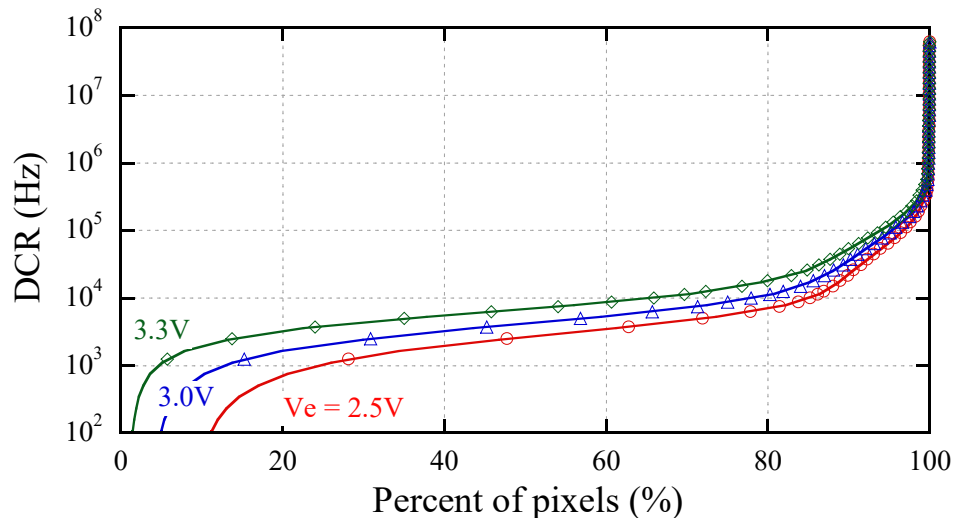
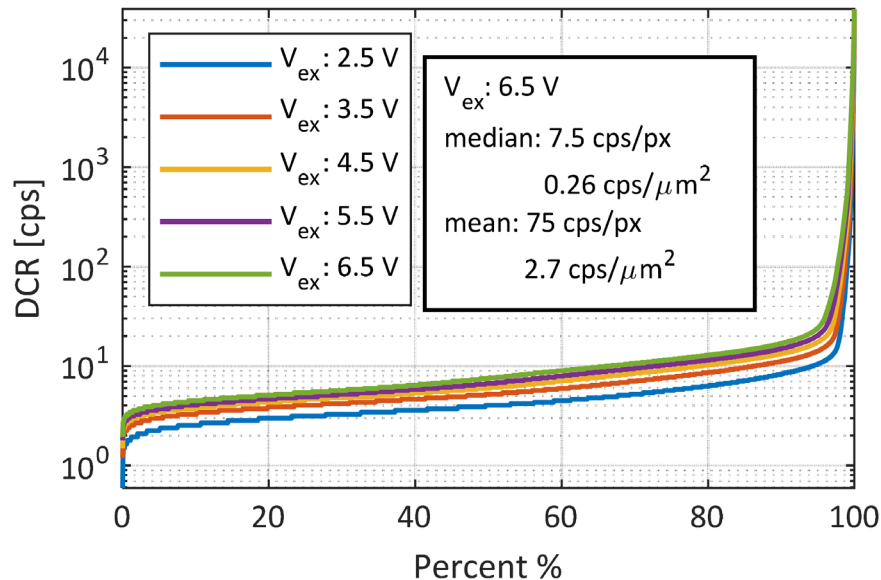


J. Ogi, et al, JSSC(56) 2021
Sony BSI 90 nm/40 nm (3D-stacked)

- Caveats: PDP vs PDE when moving from single pixel to array
- Trade-offs: microlens and product availability, isolated vs non-isolated pixels

Dark Count Rate (DCR)

- DCR (Dark Count Rate) population examples:
 - Left: SwissSPAD2 512x512px, 16.38 μm pitch, 10.5% fill factor native $\rightarrow$ reduced DCR and crosstalk
 - Right: older 0.35 μm node
- Process dependent – not easy to obtain the corresponding statistics (large population)

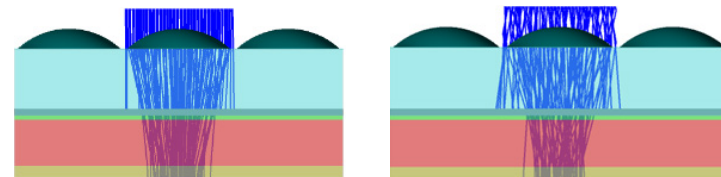
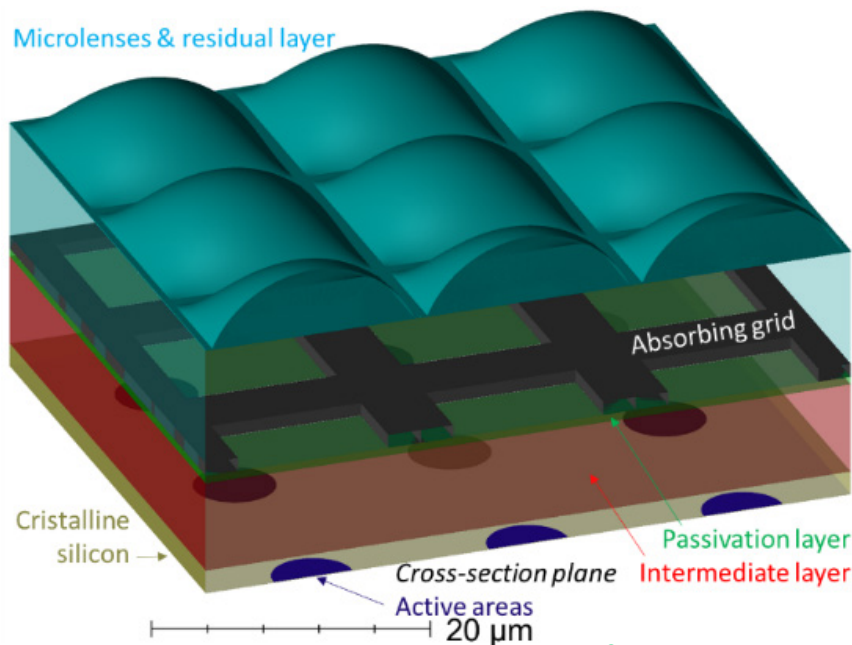


Courtesy: Yuki Maruyama

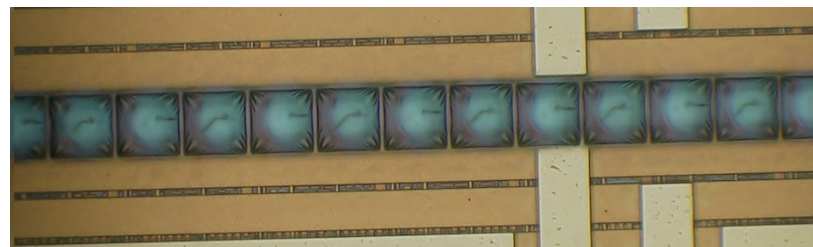
EPFL Fill Factor Recovery by means of Microlenses

10

- Alignment marks/crosses needed!
- Optimised imprints possible on small quantities (sag/residual height)



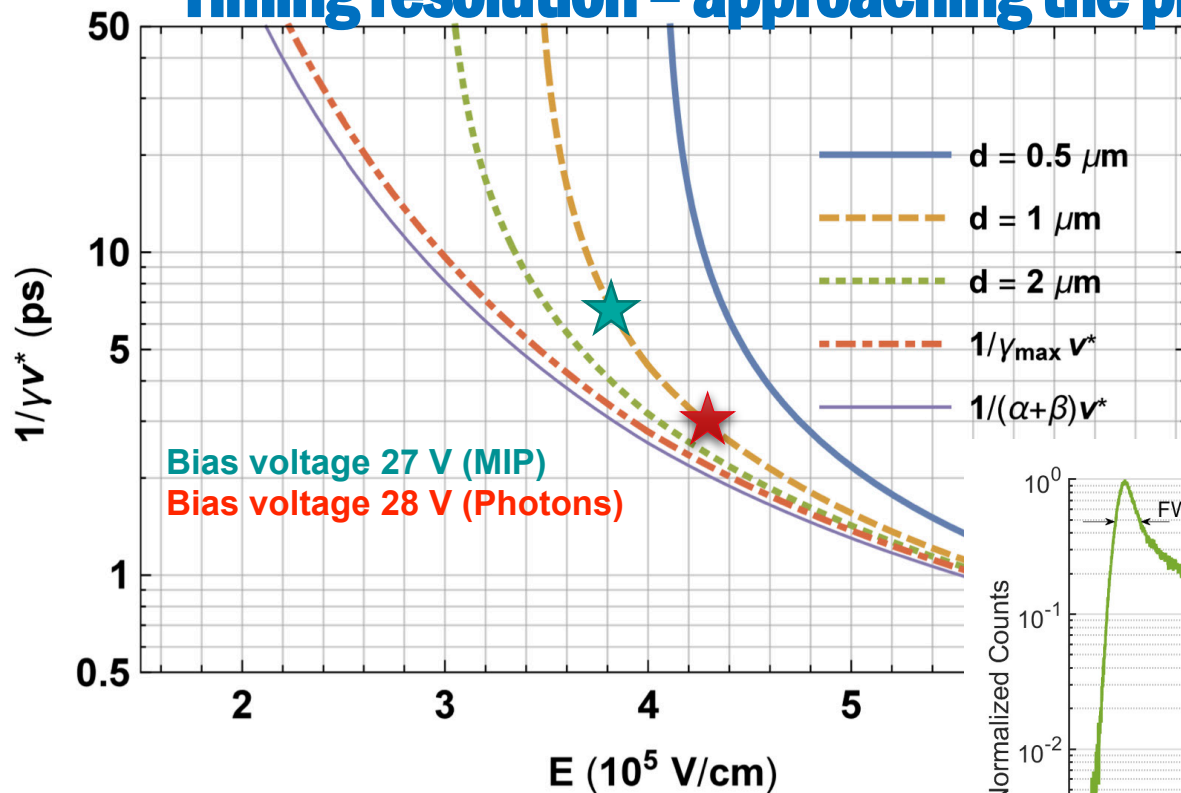
Low NA vs. high NA
→ Issues with scintillators!



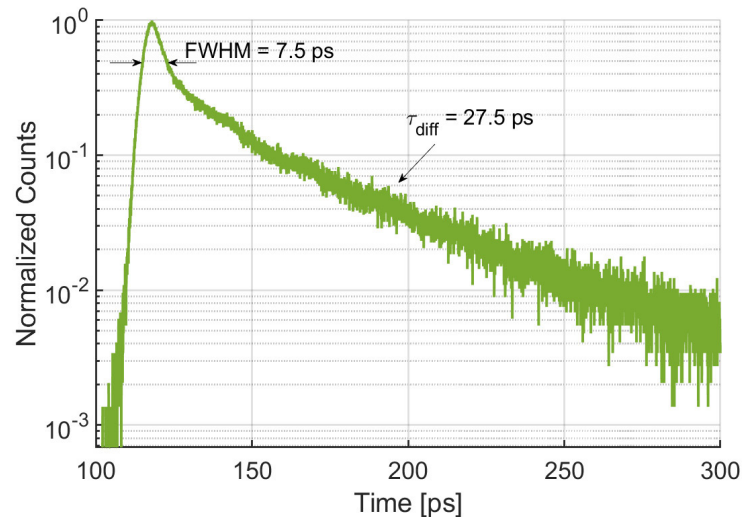
R&D, die or reticle level, imprint

- [Bruschini et al., OpEx(31) 2023]

Timing resolution – approaching the physical limits



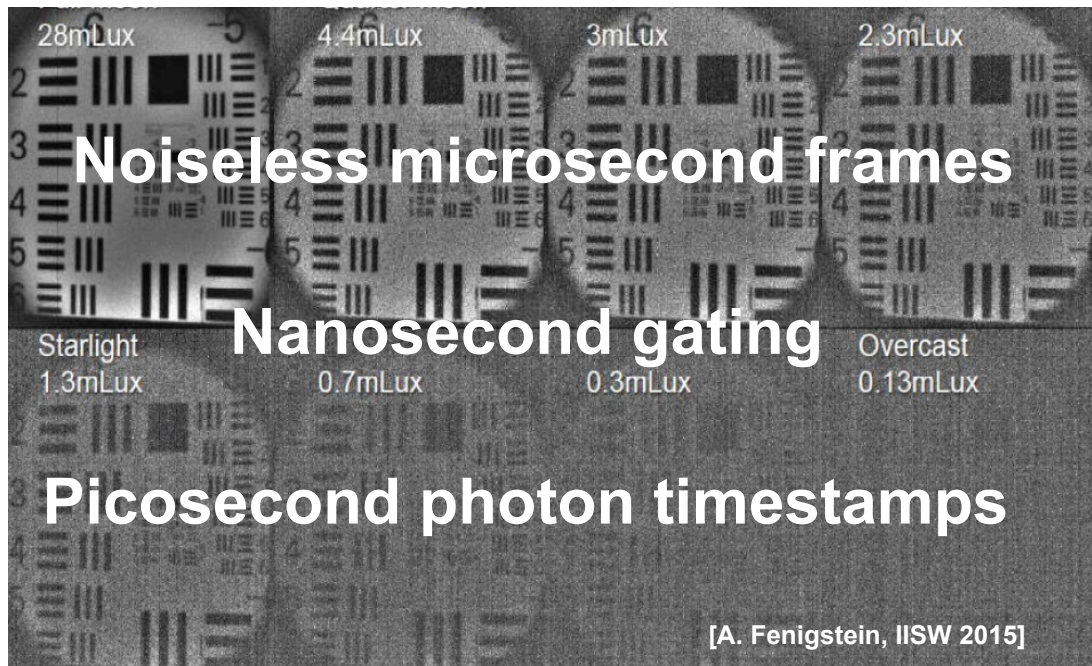
F. Gramuglia, et al., *Frontiers in Physics*(10) 2022



W. Riegler, P. Windischhofer, P. Time Resolution and Efficiency of SPADs and SiPMs for Photons and Charged Particles. *NIM A* (2021)

CMOS SPAD-based R&D and Products

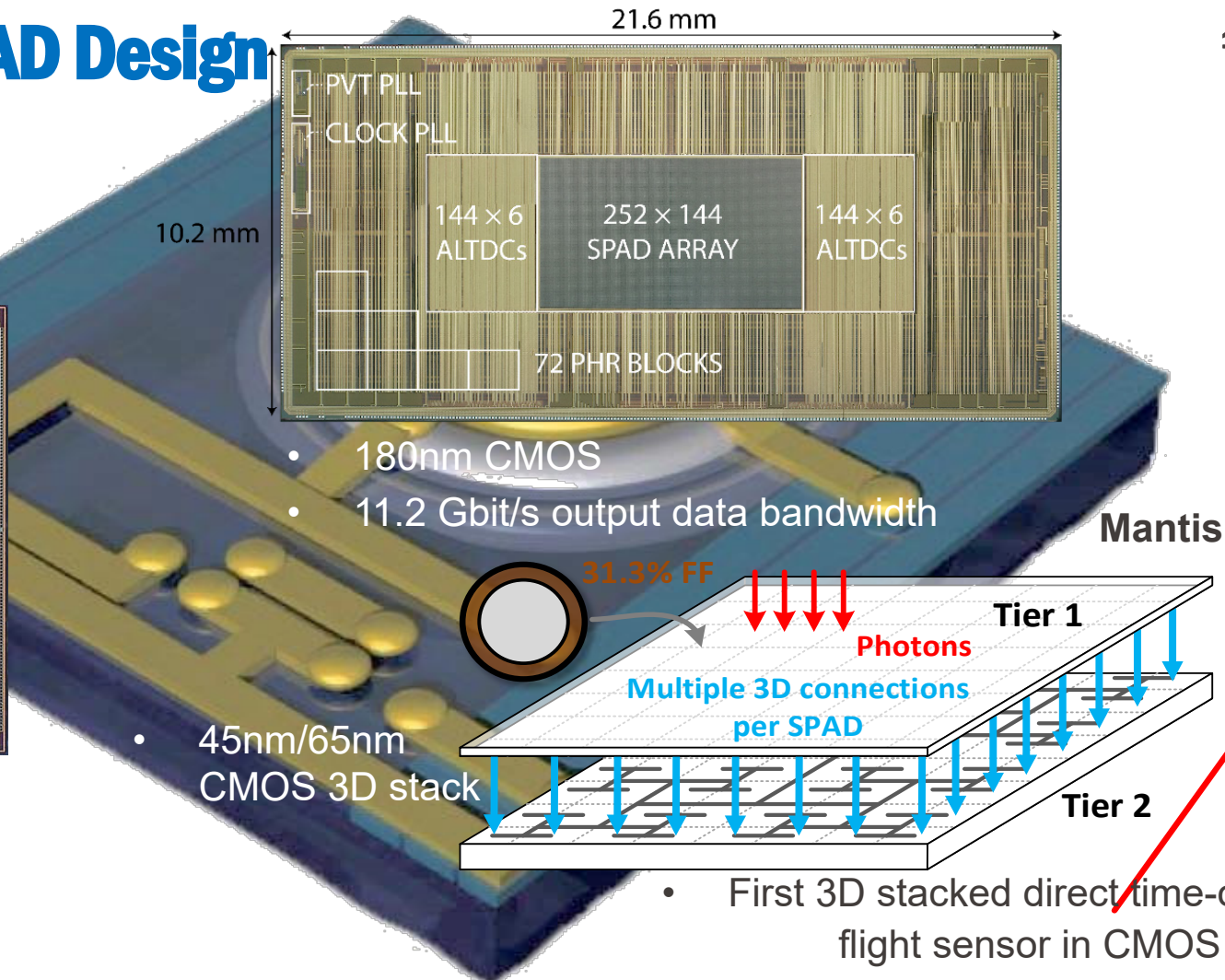
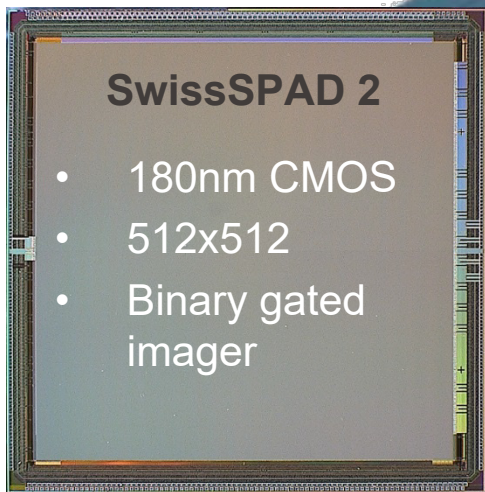
SPAD Arrays/Imagers Strengths



- [R. Henderson, IISW 2018]

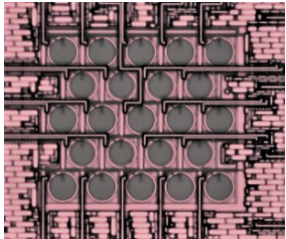
EPFL AQUA – SPAD Design Examples

14

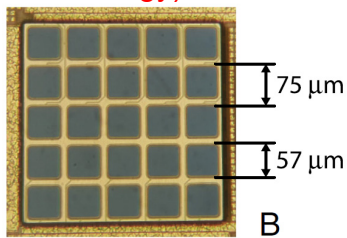


Examples of CMOS SPAD-based products

Async readout of individual pixels - excel in confocal applications



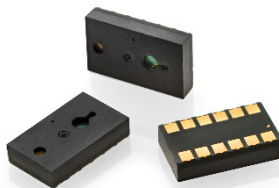
Antolović et al, OpEx 2018, FOM 2019 -
0.18 μm
SPAD23 (Pi Imaging Technology)



Buttafava et al,
Optica 2020
0.16 μm BCD



Market “push” - available off-the-shelf



VL53L5, Compact Integrated Module

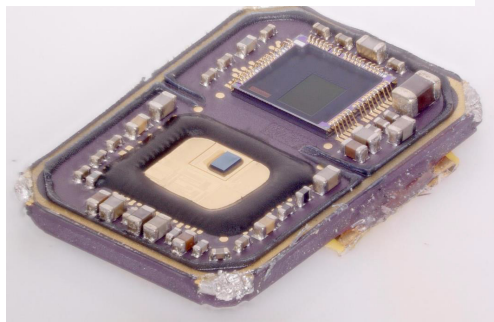
- Class 1 certified 940nm invisible VCSEL
- 61° diagonal, square FoV

Ranging Capabilities

- Up-to 64 (8x8) ranging zones
- Up-to 4m ranging per zone



[Mellot/Rae,
STMicroelectronics,
IISW 2018]



Sony iPhone 15 pro LiDAR Module /with optics removed ©2024 YoleSystemPlus

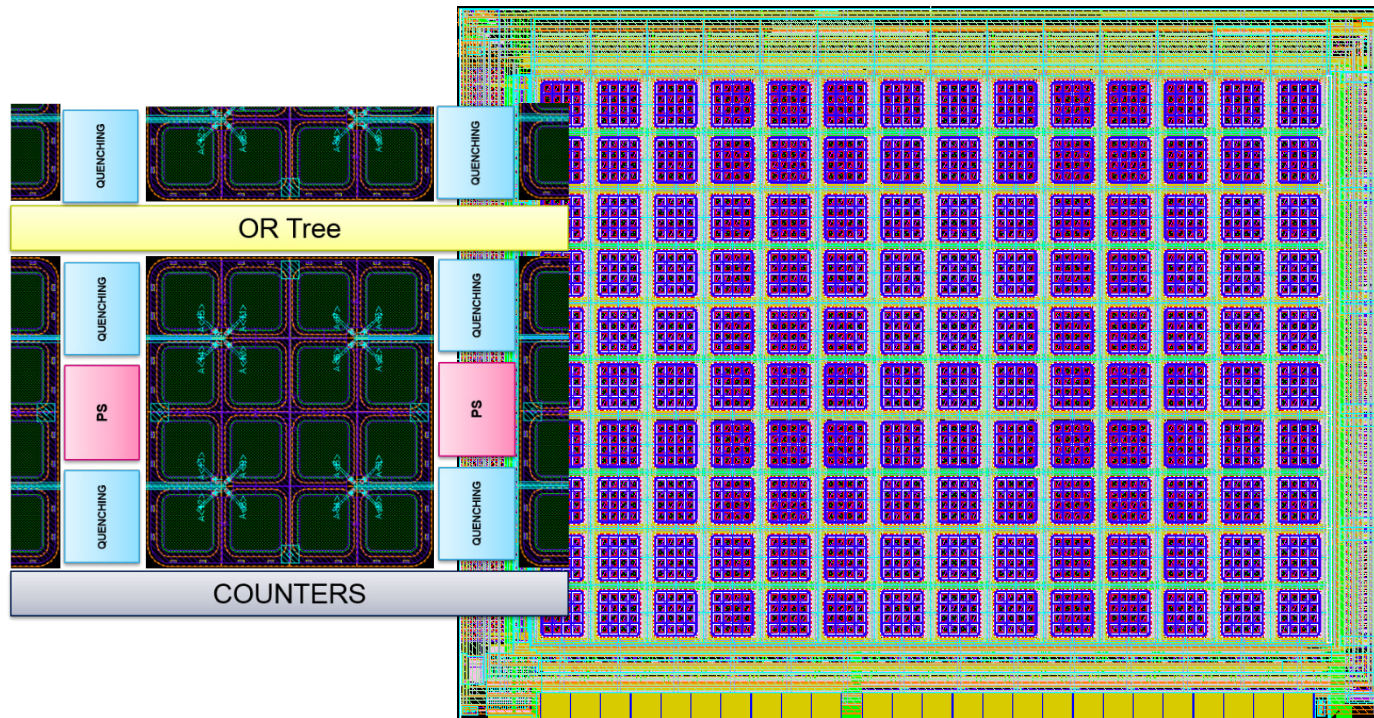
SPAD “Pixel” & Multi-Zone dSiPM Array

4 x 4 SPADs sharing NWELL

Logic

- individual quenching and enabling
- pulse shaper
- OR tree
- counters

Pixel fill factor ~ 40%



■ [Source: S. Pellegrini, STMicroelectronics ISSW 2018]

■

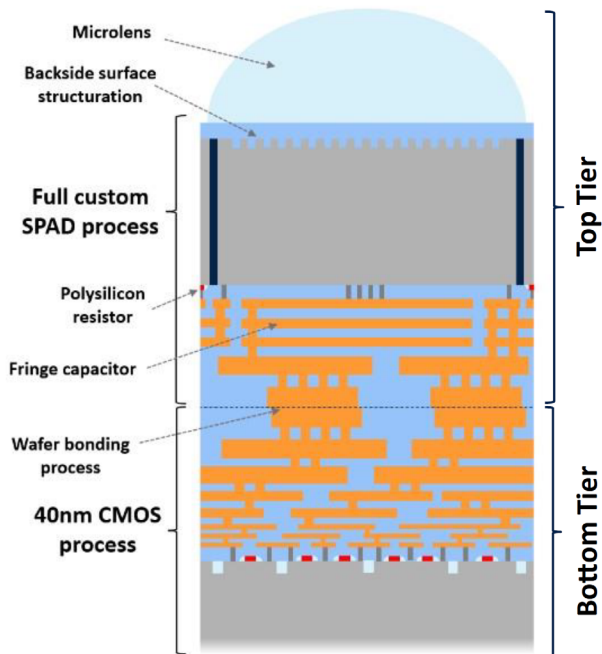
Industrialised SPAD Example – Backside illuminated

2Bu

ToF
Modules
Shipped

3D stacked SPAD technology

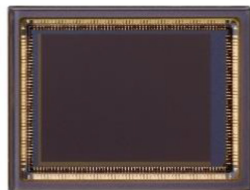
Optimized for high sensitivity, low DCR, low jitter and low power



Pixel performance

Breakdown V	19.2V
Excess bias	2.5V
DCR at 60°C	800 cps
PDE @ 940nm	21.2%
Max Count Rate	88Mcps
Jitter (FWHM)	119ps
Charge Per Pulse	68fC

Low light Level Intensity Imaging



Canon MS-500
Backside
Illuminated
3.2 Mpx

SPAD
 SENSOR

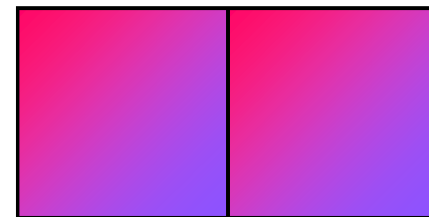
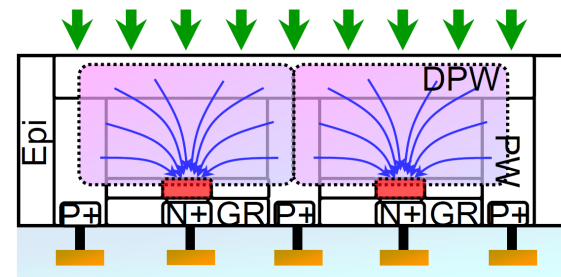


*Zoomed image of ship at 5km distance, captured at midnight

0.1%	0.4%	1.0%	0.4%	0.1%
0.4%	2.0%	4.0%	2.0%	0.4%
1.0%	4.0%	100%	4.0%	1.0%
0.4%	2.0%	4.0%	2.0%	0.4%
0.1%	0.4%	1.0%	0.4%	0.1%

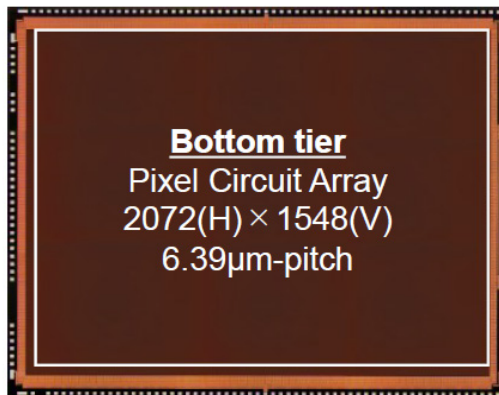
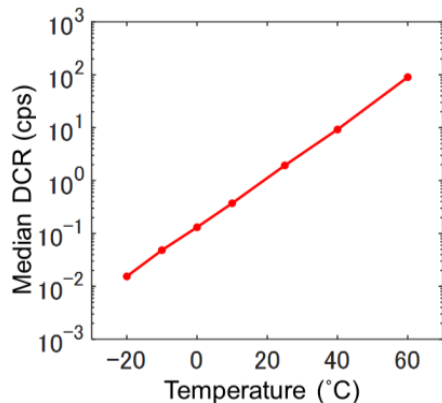
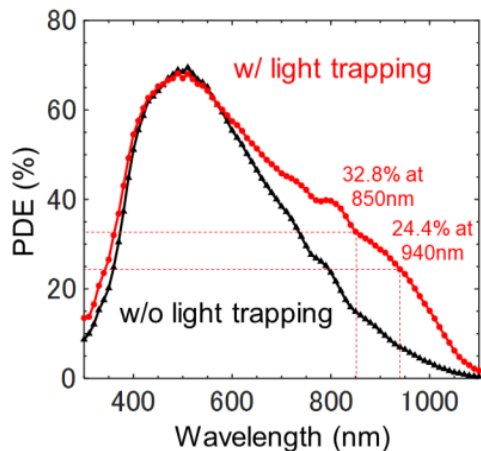
Crosstalk

Charge focusing SPAD



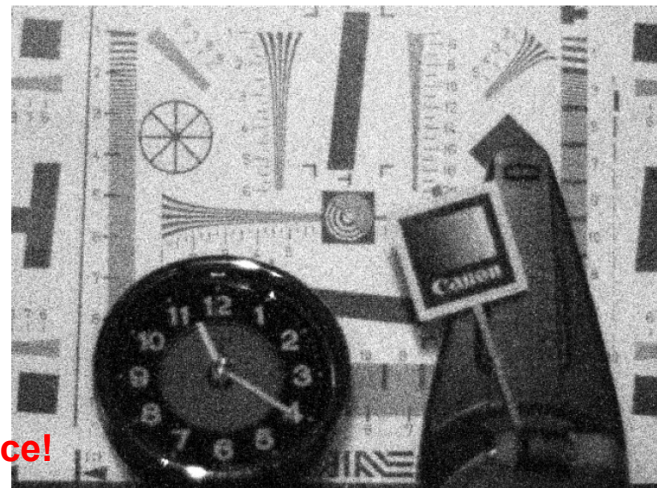
a.k.a. “electrical microlenses”

Low light Level Intensity Imaging



Canon MS-500
Backside
Illuminated
3.2 Mpx

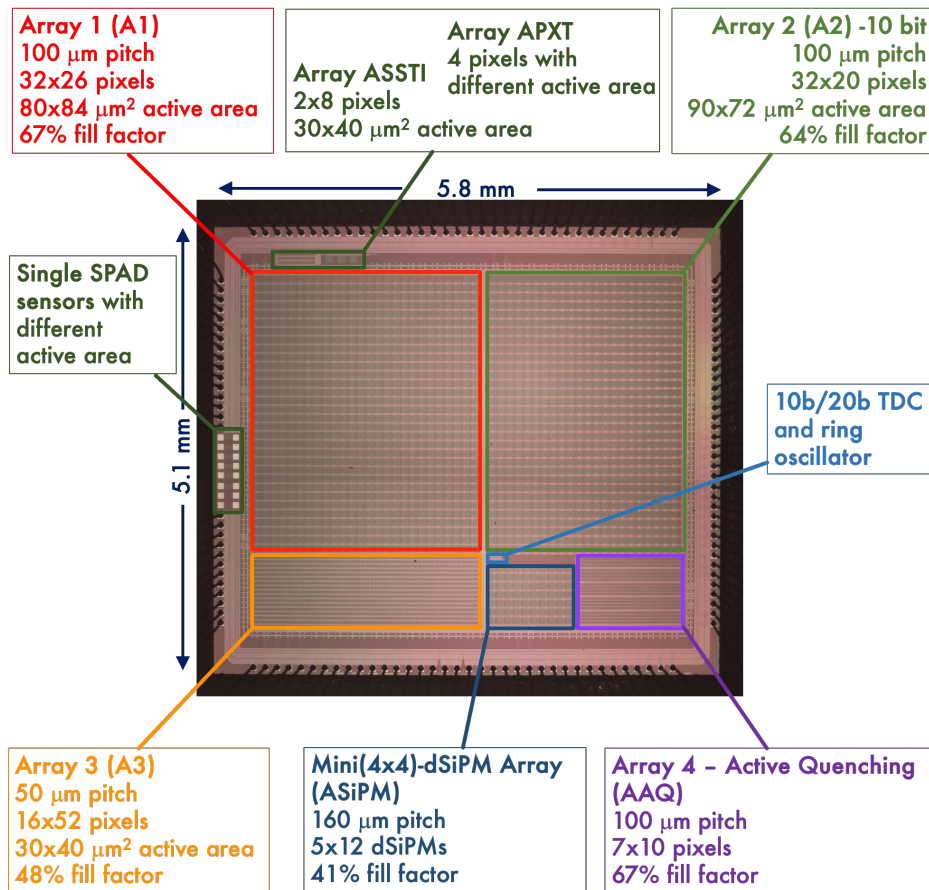
2 mLux



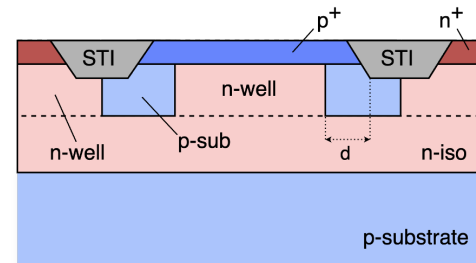
Power consumption at high illuminance!
Here: clocked recharging

- [K. Morimoto, IEDM 2021]

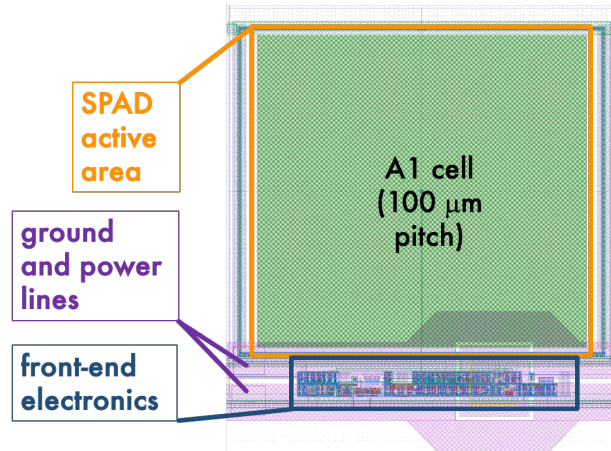
Example of technology development: SPAD test structures@110 nm²⁰



SPAD CROSS-SECTION



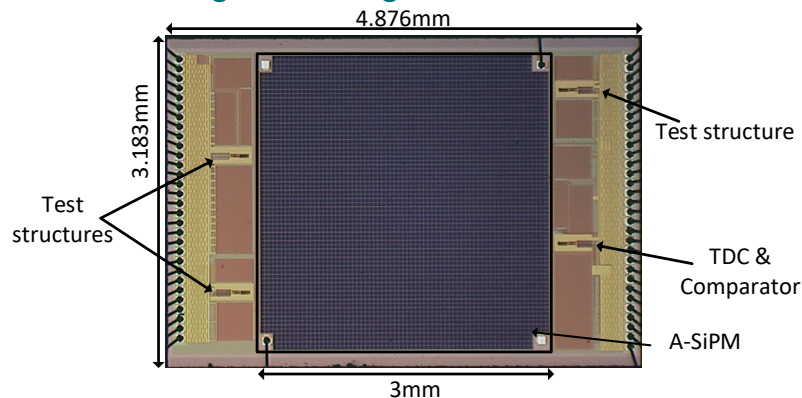
ELEMENTARY CELL LAYOUT



Examples of R&D Systems for HEP & PET

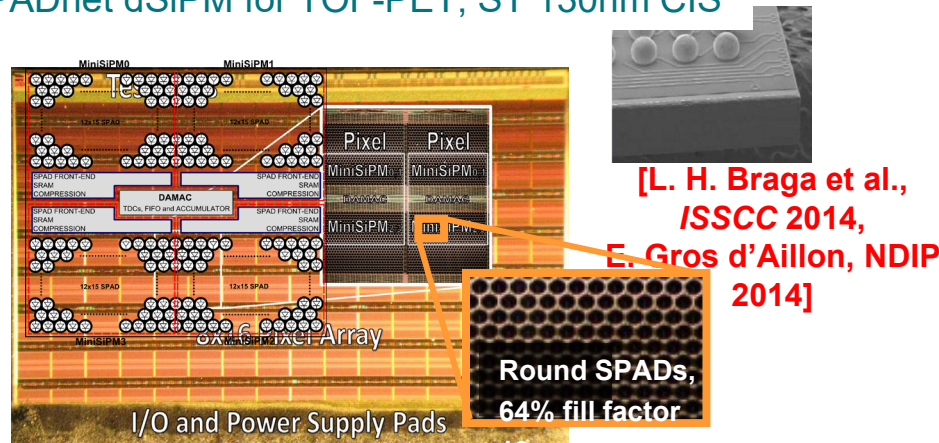
Examples of R&D Systems

Blumino digital analog SiPM SensL, 350nm

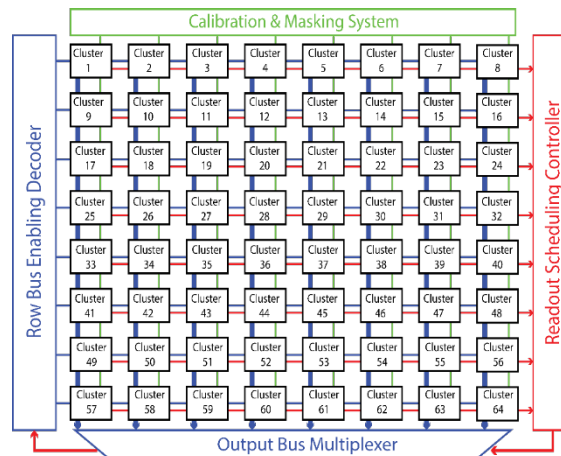
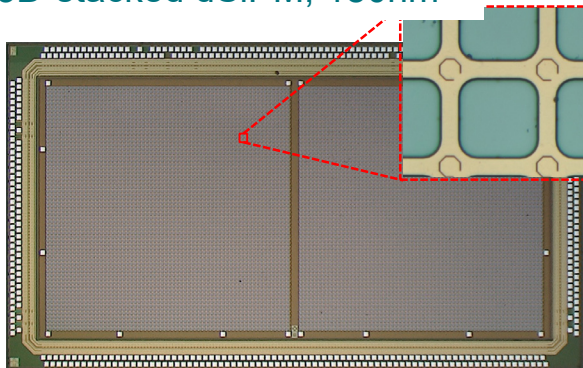


[A. Muntean et al., IEEE TRPMS(5) 2021]

SPADnet dSiPM for TOF-PET, ST 130nm CIS



Blueberry FSI 3D-stacked dSiPM, 180nm



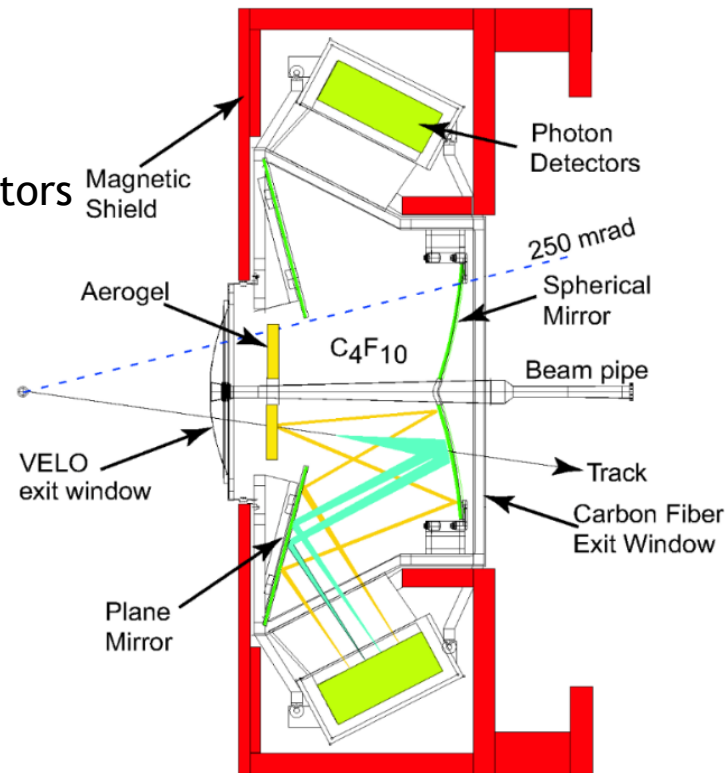
[F. Gramuglia, et al, NSS-MIC 2021, IISW 2021]

spadRICH

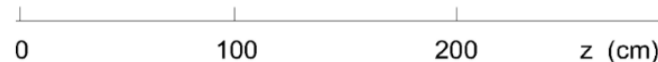
*EPFL, JSI – R. Dolenec, R. Pestotnik:
monolithic dSiPMs for future RICH detectors*



- Planned upgrades of Ring Imaging Cherenkov (RICH) detectors
 - LHCb, Belle II, ALICE3
- High performance requirements for photodetectors used
 - magnetic field
 - timing resolution
 - Cherenkov angular resolution → small channel size
 - channel occupancy
 - background radiation
- **Silicon Photomultiplier (SiPM)**
 - main candidate
 - main issue: **neutron radiation damage**

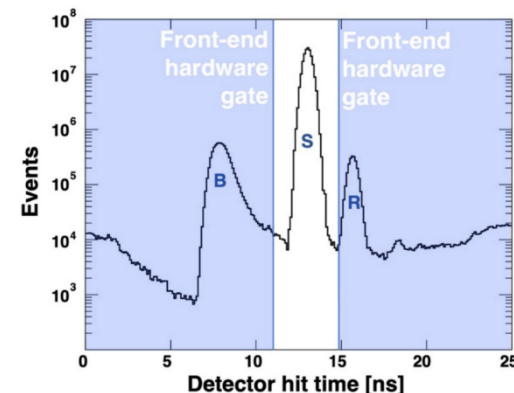
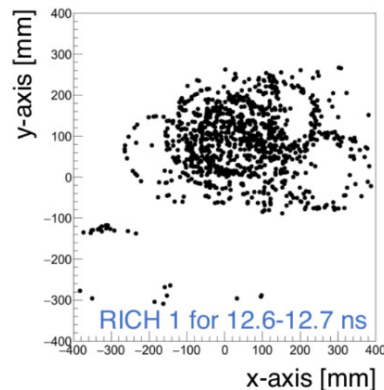
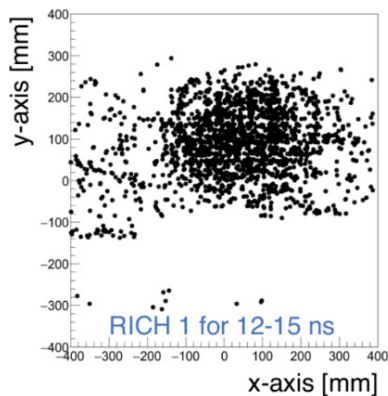
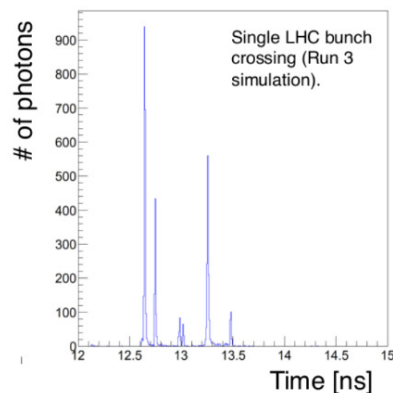
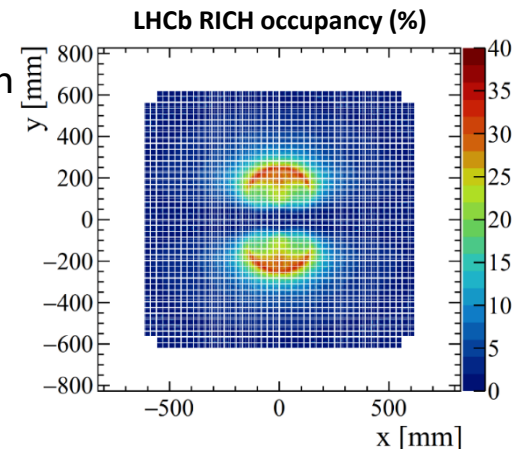


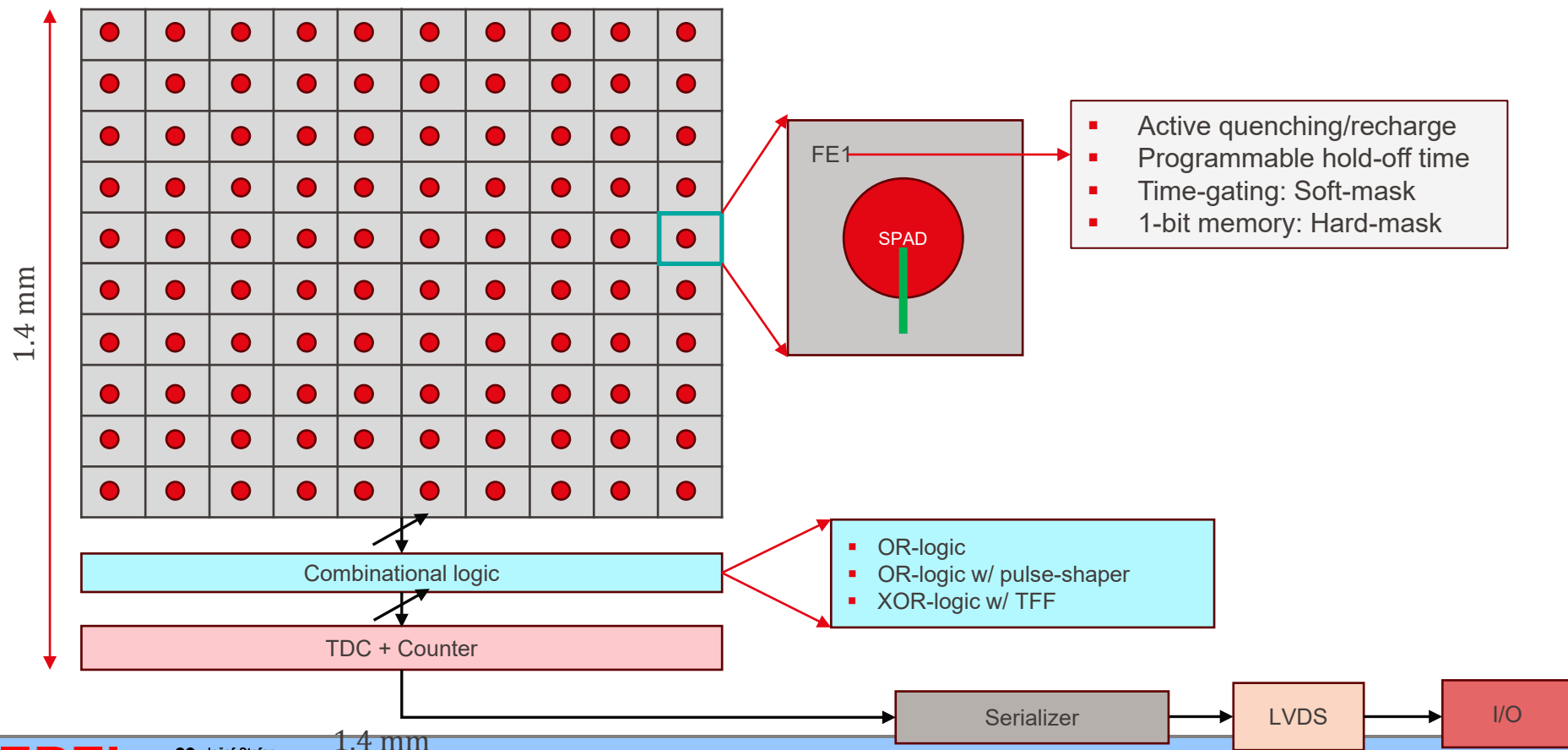
LHCb RICH1:



- Fast timing
 - Nanosecond front-end gate - background and data throughput reduction
 - Picosecond hit timestamps - reduce combinatorial background
- Cherenkov angle resolution
 - High granularity $\sim 1 \times 1 \text{ mm}^2$ - also to reduce photon occupancy
 - Enhanced sensitivity in green - enable chromatic error reduction

Occupancy: 1-photon hit probability/channel/bunch crossing (25 ns)



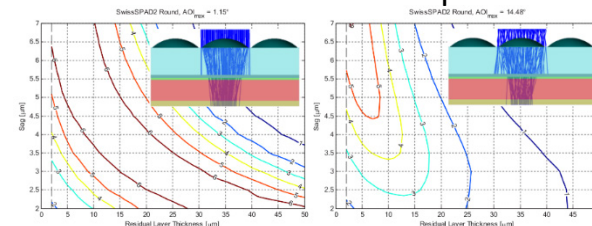


- Small SPAD area $\rightarrow$ improved radiation hardness, microlenses $\rightarrow$ recover effective active area
- Simulated photon hit distributions in LHCb RICH (upper detector):

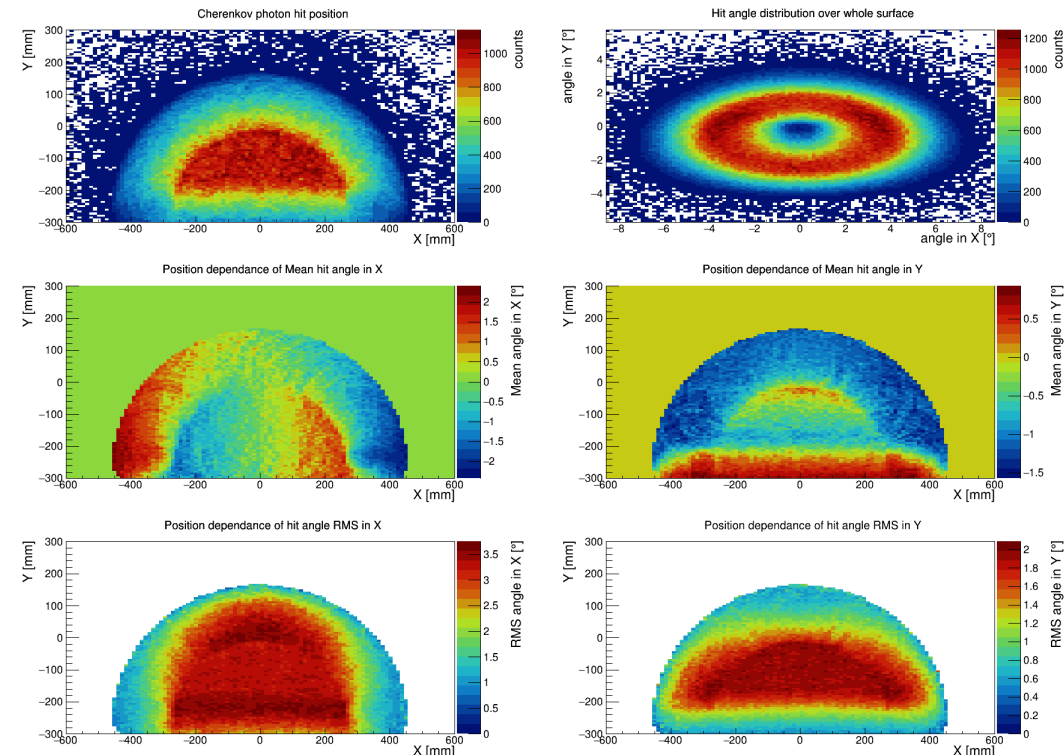
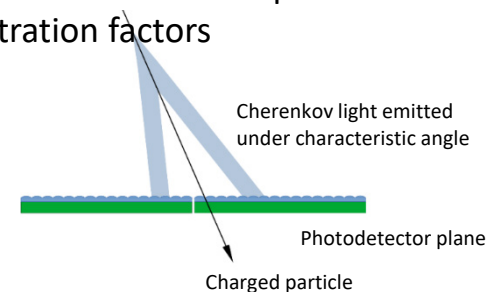
Maximum required micro-lens acceptance
half angle $\approx 6^\circ$

$\rightarrow$ Relatively modest NA ≈ 0.1 / $f \approx 5$

$\rightarrow$ Good concentration factor possible



Possible position dependent optimization of
microlenses to further improve
concentration factors



spadRICH: monolithic dSiPM for future RICH detectors



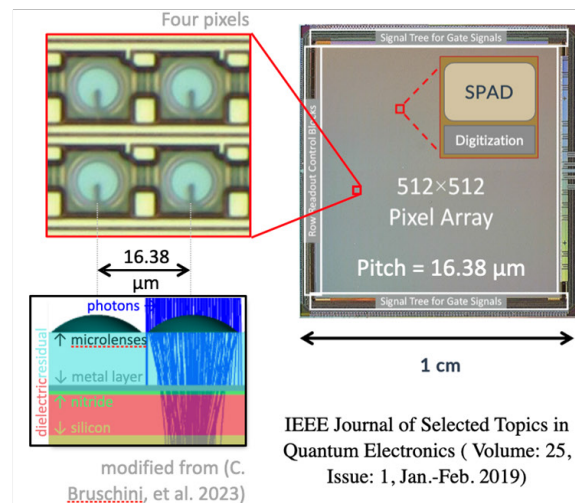
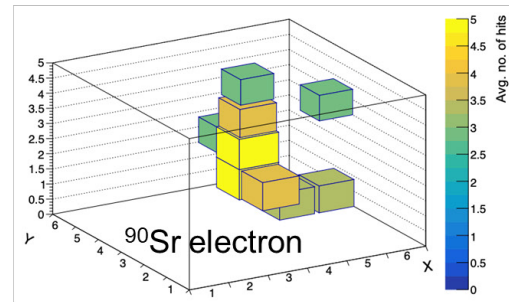
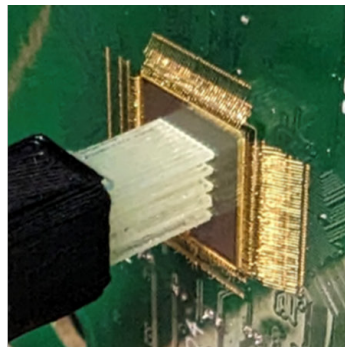
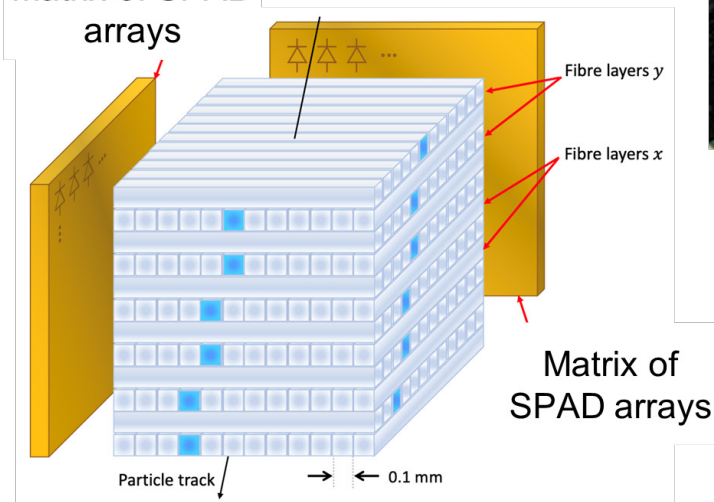
- Constraints:
 - Granularity down to $1 \times 1 \text{ mm}^2$
 - Timing precision $\sim 100 \text{ ps}$, 40 MHz trigger (25 ns), few ns gating
 - Switching off hot pixels, 30% occupancy
 - Radiation hardness (2×10^{13} 1-MeV neutron equivalent/cm²)
- ~Collimated light -> use of microlenses to recover fill factor and reduce radiation damage looks feasible
- Possible cryogenic operation, but afterpulsing challenge in irradiated detectors
- Initial activities:
 - Radiation hardness measurements (neutrons up to 10^{12} neq/cm^2 @TRIGA) in 180 nm (actively quenched SPADs), GF 55nm BCD and 110 nm
 - Operation at cryogenic temperature (starting)
 - Microlenses: radiation hardness measurements and cryogenic operation

PLATON

ETH (D. Sgalaberna), EPFL:
neutrino tracking / scintillating fibres, monolithic dSiPMs

Goal for future neutrino near detectors is tracking low-momentum protons

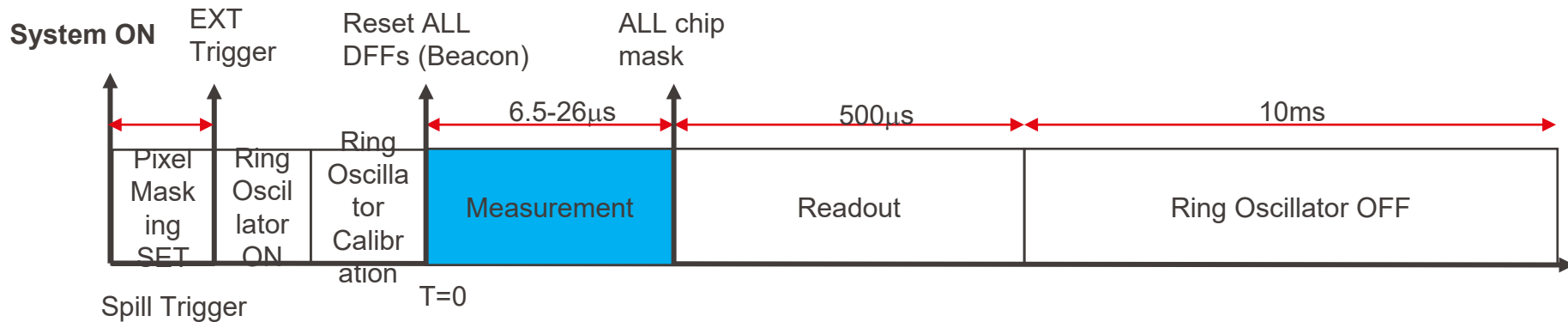
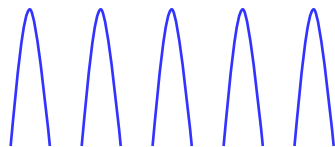
Matrix of SPAD arrays



- The concept has been proven w/ SwissSPAD2
- Developing novel SPAD sensor (see later)

Event structure of neutrino beam trigger @T2K/HK

Neutrino Bunches

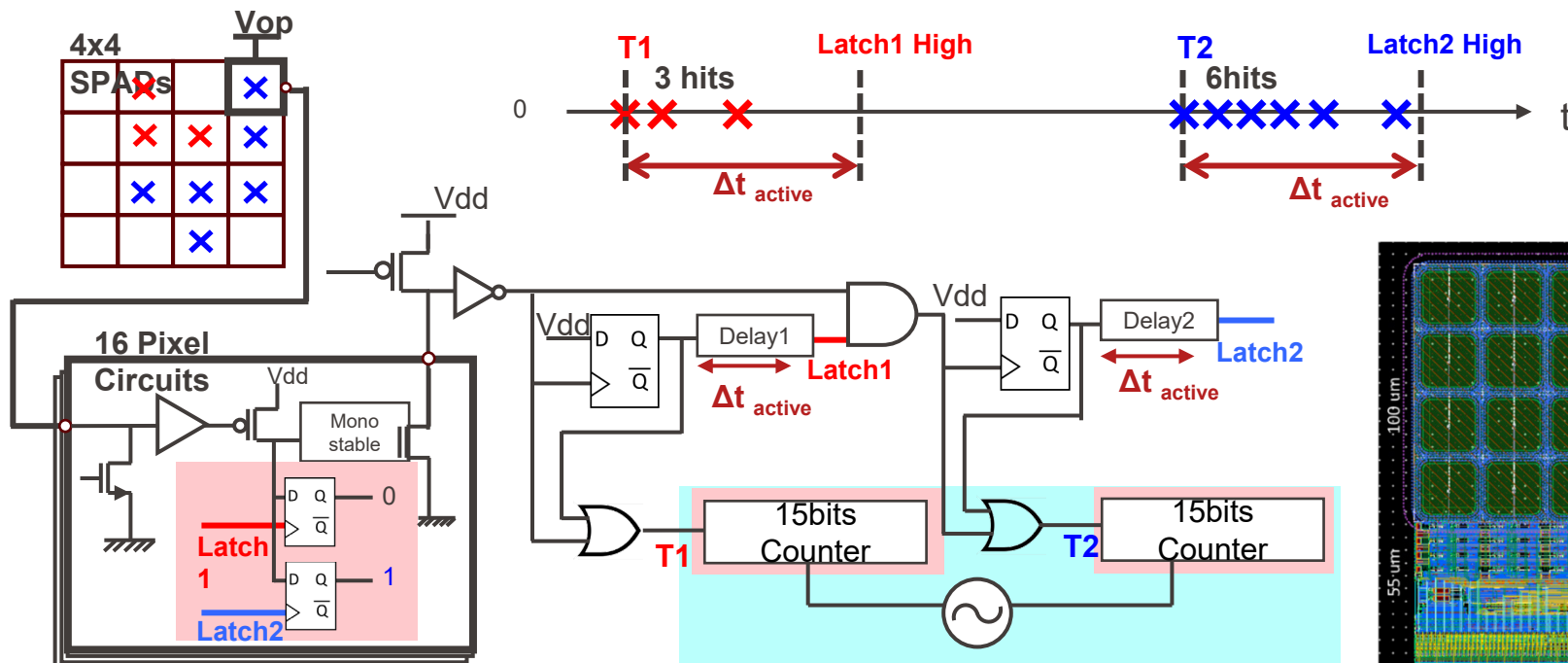


- Next cycle: 1 second later $\rightarrow$ ample time for read-out vs parallelisation
- Ring oscillators can be switched off in-between spills ($\rightarrow$ power saving).
Need however to be recalibrated before each measurement.

PLATON Pixel Architecture/1

4*4 SPAD array with TDC

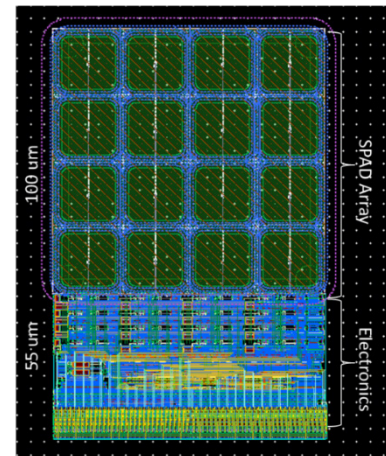
- Asynchronous TDC for event driven architecture
- Taking 2 sub-images per spill



2. Multiple counters for spatial map

1. Asynchronous TDC

■ Kodai Kaneyasu (EPFL)



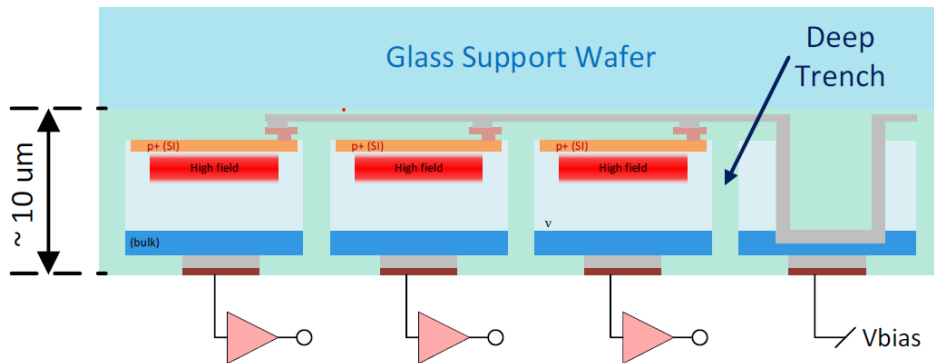
aqualab

DIGILOG

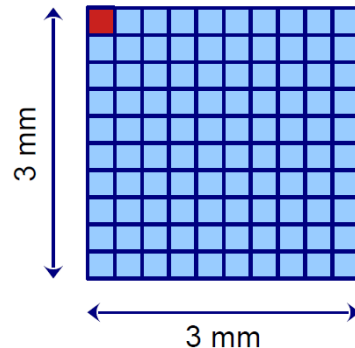
EPFL, RWTH – V. Schulz & S. Gundacker, FBK:
3D-stacked FSI digital analog-SiPM for ToF-PET



DIGILOG: Segmentation and 3D stacking

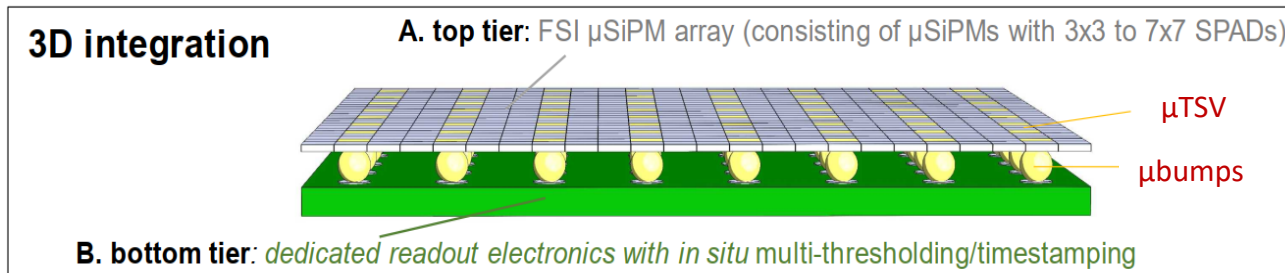


SiPM: $3 \times 3 \text{ mm}^2$
 SPAD: $50 \times 50 \mu\text{m}^2$
 $10 \times 10 \mu\text{SiPM}$ array
 (36 SPADs per μSiPM)



Lower capacitance $C \rightarrow$ higher electrical signal $\rightarrow$ possible to detect the 1st photon
 Smaller SiPM size $\rightarrow$ better SPTR

Single Cell TSV: Backside contacts + RDL (redistribution layer)

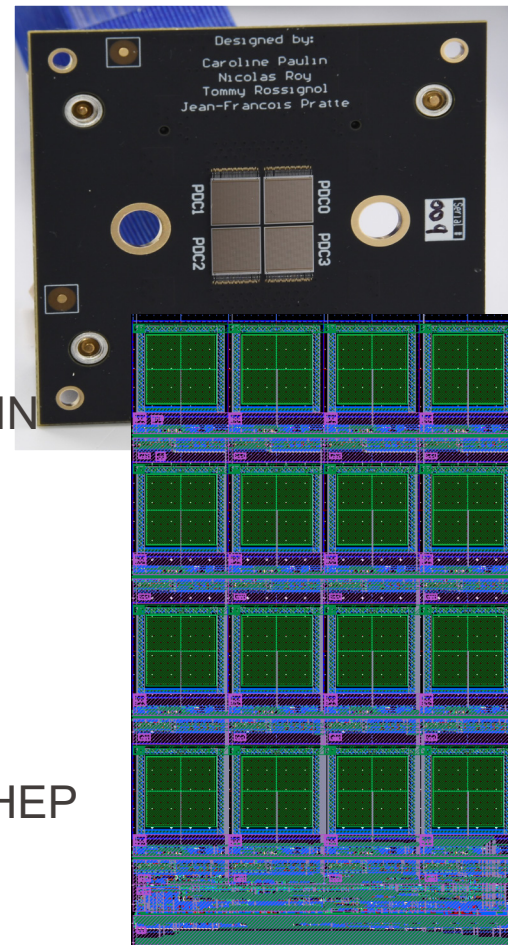


Gundacker, S et al. (2023). "DIGILOG: A digital-analog SiPM...", *IEEE NSS-MIC*.

Gola, A et al. (2024). FBK roadmap towards the next-generation of 3D-integrated SiPM and SPAD technologies.

dSiPMs for other HEP/nuclear applications

- Univ. of Sherbrooke (Canada, S. Charlebois, J.-F. Pratte): dSiPMs for HEP and related applications – PDC platform →
- I. Diehl, DESY (Hamburg, Germany)
- P. Fischer, M. Keller, Univ. of Heidelberg (Germany) – DARWIN
- Fabrice Retière (TRIUMPF, Canada)
- FERMIlab – DUNE collaboration
- L. Ratti (Pavia, Italy) & colleagues: stacked SPAD arrays for HEP tracking (coincidence detection) & dSiPMs (ASPIDES INFN) →



Summary & Conclusions

Final Considerations

- SPAD products do exist either for volume (e.g. ranging, low light level imaging) or for specific applications (e.g. microscopy/scientific)
- Analog vs digital vs “hybrid” - Design life cycles (more demanding in fully digital approaches)
- Foundry access still a very important item
 - Multi-project wafer vs. full (dedicated) runs
 - Focus on NIR for certain applications (e.g. LIDAR)
- No “one size fits all” device → harder to assemble a critical design/sponsoring mass?
- Exploit applications where there is an added value from the digital circuitry
 - Higher granularity, spatial and/or temporal
 - Added functionality, like switching off noisy SPADs, or control hold-off time
 - “Ultimate” performance (e.g. timing)
- Tiling is still a specific requirement of HEP/nuclear physics (and PET...)

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